

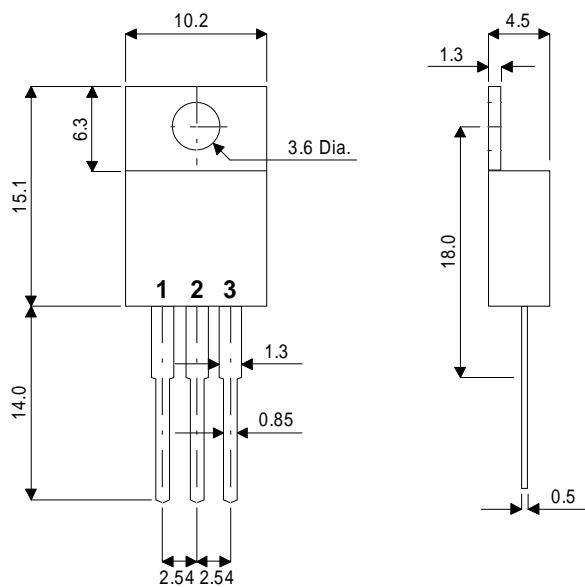


**SEME
LAB**

BUL54A

MECHANICAL DATA

Dimensions in mm



TO220

Pin 1 – Base

Pin 2 – Collector

Pin 3 – Emitter

ADVANCED DISTRIBUTED BASE DESIGN HIGH VOLTAGE HIGH SPEED NPN SILICON POWER TRANSISTOR

Designed for use in
electronic ballast applications

- SEMEFAB DESIGNED AND DIFFUSED DIE
- HIGH VOLTAGE
- FAST SWITCHING
- HIGH ENERGY RATING
- MILITARY AND HI-REL VERSIONS
AVAILABLE IN METAL AND CERAMIC
SURFACE MOUNT PACKAGES

FEATURES

- Multi-base for efficient energy distribution across the chip resulting in significantly improved switching and energy ratings across full temperature range.
- Ion implant and high accuracy masking for tight control of characteristics from batch to batch.
- Triple Guard Rings for improved control of high voltages.

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^\circ\text{C}$ unless otherwise stated)

V_{CBO}	Collector – Base Voltage	1000V
V_{CEO}	Collector – Emitter Voltage ($I_B = 0$)	500V
V_{EBO}	Emitter – Base Voltage ($I_C = 0$)	10V
I_C	Continuous Collector Current	4A
$I_{C(PK)}$	Peak Collector Current	7A
I_B	Base Current	2A
P_{tot}	Total Dissipation at $T_{case} = 25^\circ\text{C}$	65W
T_{stg}	Operating and Storage Temperature Range	-55 to +150°C



**SEME
LAB**

BUL54A

ELECTRICAL CHARACTERISTICS ($T_{case} = 25^\circ\text{C}$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
ELECTRICAL CHARACTERISTICS					
$V_{CEO(sus)}$	Collector – Emitter Sustaining Voltage	$I_C = 10\text{mA}$	500		V
$V_{(BR)CBO}$	Collector – Base Breakdown Voltage	$I_C = 1\text{mA}$	1000		
$V_{(BR)EBO}$	Emitter – Base Breakdown Voltage	$I_E = 1\text{mA}$	10		
I_{CBO}	Collector – Base Cut-Off Current	$V_{CB} = 1000\text{V}$ $T_C = 125^\circ\text{C}$		10	μA
I_{CEO}	Collector – Emitter Cut-Off Current	$I_B = 0$ $V_{CE} = 500\text{V}$		100	
I_{EBO}	Emitter Cut-Off Current	$V_{EB} = 9\text{V}$ $I_C = 0$ $T_C = 125^\circ\text{C}$		10	μA
h_{FE}^*	DC Current Gain	$I_C = 0.1\text{A}$ $V_{CE} = 5\text{V}$	20	40	—
		$I_C = 0.5\text{A}$ $V_{CE} = 5\text{V}$	12	15	
		$I_C = 1\text{A}$ $V_{CE} = 1\text{V}$ $T_C = 125^\circ\text{C}$	5	8	
$V_{CE(sat)*}$	Collector – Emitter Saturation Voltage	$I_C = 100\text{mA}$ $I_B = 20\text{mA}$		0.05	V
		$I_C = 0.5\text{A}$ $I_B = 0.1\text{A}$		0.15	
		$I_C = 1\text{A}$ $I_B = 0.2\text{A}$		0.3	
$V_{BE(sat)*}$	Base – Emitter Saturation Voltage	$I_C = 0.5\text{A}$ $I_B = 0.1\text{A}$		0.8	V
		$I_C = 1\text{A}$ $I_B = 0.2\text{A}$		0.9	
DYNAMIC CHARACTERISTICS					
f_t	Transition Frequency	$I_C = 0.2\text{A}$ $V_{CE} = 4\text{V}$		20	MHz
C_{ob}	Output Capacitance	$V_{CB} = 20\text{V}$ $f = 1\text{MHz}$		20	pF

* Pulse test $t_p = 300\mu\text{s}$, $\delta < 2\%$